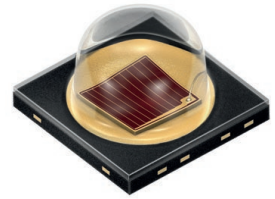


# LA H9GP

## OSLON® Black

OSLON Black Series combines thermal stability with high performance and reliability in a compact black package. It has a metal lead frame and a tried and tested lens design. The LED can be used wherever there are large fluctuations in temperature and a large amount of light is needed from a small area.



## Applications

- Cluster, Button Backlighting
- Custom Tuning
- Head-Up Display LED & Laser
- Interior Illumination (e.g. Ambient Map)
- Transportation, Plane, Ship

## Features:

- Package: SMD epoxy package with silicone lens
- Chip technology: Thinfilm
- Typ. Radiation: 90°
- Color:  $\lambda_{\text{dom}} = 617 \text{ nm}$  (● amber)
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

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## Ordering Information

| Type                 | Luminous Flux <sup>1)</sup><br>$I_F = 350 \text{ mA}$<br>$\Phi_V$ | Ordering Code |
|----------------------|-------------------------------------------------------------------|---------------|
| LA H9GP-JYKZ-24-H29C | 52 ... 112 lm                                                     | Q65112A3113   |

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## Maximum Ratings

| Parameter                                                               | Symbol    |      | Values  |
|-------------------------------------------------------------------------|-----------|------|---------|
| Operating Temperature                                                   | $T_{op}$  | min. | -40 °C  |
|                                                                         |           | max. | 125 °C  |
| Storage Temperature                                                     | $T_{stg}$ | min. | -40 °C  |
|                                                                         |           | max. | 125 °C  |
| Junction Temperature                                                    | $T_j$     | max. | 150 °C  |
| Junction Temperature for short time applications*                       | $T_j$     | max. | 175 °C  |
| Forward current                                                         | $I_F$     | min. | 100 mA  |
| $T_s = 25\text{ °C}$                                                    |           | max. | 1000 mA |
| Surge Current                                                           | $I_{FS}$  | max. | 2500 mA |
| $t \leq 10\text{ }\mu\text{s}$ ; $D = 0.016$ ; $T_s = 25\text{ °C}$     |           |      |         |
| ESD withstand voltage<br>acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B) | $V_{ESD}$ |      | 8 kV    |
| Reverse current <sup>2)</sup>                                           | $I_R$     | max. | 200 mA  |

\* The median lifetime (L70/B50) for  $T_j = 175\text{ °C}$  is 100h.

## Characteristics

$I_F = 350 \text{ mA}$ ;  $T_s = 25 \text{ °C}$

| Parameter                                                   | Symbol                  |      | Values     |
|-------------------------------------------------------------|-------------------------|------|------------|
| Peak Wavelength                                             | $\lambda_{\text{peak}}$ | typ. | 624 nm     |
| Dominant Wavelength <sup>3)</sup><br>$I_F = 350 \text{ mA}$ | $\lambda_{\text{dom}}$  | min. | 612 nm     |
|                                                             |                         | typ. | 617 nm     |
|                                                             |                         | max. | 624 nm     |
| Spectral Bandwidth at 50% $I_{\text{rel,max}}$              | $\Delta\lambda$         | typ. | 18 nm      |
| Viewing angle at 50% $I_V$                                  | $2\phi$                 | typ. | 90 °       |
| Forward Voltage <sup>4)</sup><br>$I_F = 350 \text{ mA}$     | $V_F$                   | min. | 1.95 V     |
|                                                             |                         | typ. | 2.20 V     |
|                                                             |                         | max. | 2.65 V     |
| Reverse voltage (ESD device)                                | $V_{\text{RESD}}$       | min. | 45 V       |
| Reverse voltage <sup>2)</sup><br>$I_R = 20 \text{ mA}$      | $V_R$                   | max. | 1.2 V      |
|                                                             |                         |      |            |
| Real thermal resistance junction/solderpoint <sup>5)</sup>  | $R_{\text{thJS real}}$  | typ. | 6.5 K / W  |
|                                                             |                         | max. | 11.0 K / W |

## Brightness Groups

| Group | Luminous Flux <sup>1)</sup><br>$I_F = 350 \text{ mA}$<br>min.<br>$\Phi_V$ | Luminous Flux <sup>1)</sup><br>$I_F = 350 \text{ mA}$<br>max.<br>$\Phi_V$ | Luminous Intensity <sup>6)</sup><br>$I_F = 350 \text{ mA}$<br>typ.<br>$I_v$ |
|-------|---------------------------------------------------------------------------|---------------------------------------------------------------------------|-----------------------------------------------------------------------------|
| JY    | 52 lm                                                                     | 61 lm                                                                     | 28 cd                                                                       |
| JZ    | 61 lm                                                                     | 71 lm                                                                     | 33 cd                                                                       |
| KX    | 71 lm                                                                     | 82 lm                                                                     | 38 cd                                                                       |
| KY    | 82 lm                                                                     | 97 lm                                                                     | 44 cd                                                                       |
| KZ    | 97 lm                                                                     | 112 lm                                                                    | 51 cd                                                                       |

## Forward Voltage Groups

| Group | Forward Voltage <sup>4)</sup><br>$I_F = 350 \text{ mA}$<br>min.<br>$V_F$ | Forward Voltage <sup>4)</sup><br>$I_F = 350 \text{ mA}$<br>max.<br>$V_F$ |
|-------|--------------------------------------------------------------------------|--------------------------------------------------------------------------|
| H2    | 1.95 V                                                                   | 2.05 V                                                                   |
| 9B    | 2.05 V                                                                   | 2.35 V                                                                   |
| 9C    | 2.35 V                                                                   | 2.65 V                                                                   |

## Wavelength Groups

| Group | Dominant Wavelength <sup>3)</sup><br>$I_F = 350 \text{ mA}$<br>min.<br>$\lambda_{\text{dom}}$ | Dominant Wavelength <sup>3)</sup><br>$I_F = 350 \text{ mA}$<br>max.<br>$\lambda_{\text{dom}}$ |
|-------|-----------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------|
| 2     | 612 nm                                                                                        | 616 nm                                                                                        |
| 3     | 616 nm                                                                                        | 620 nm                                                                                        |
| 4     | 620 nm                                                                                        | 624 nm                                                                                        |

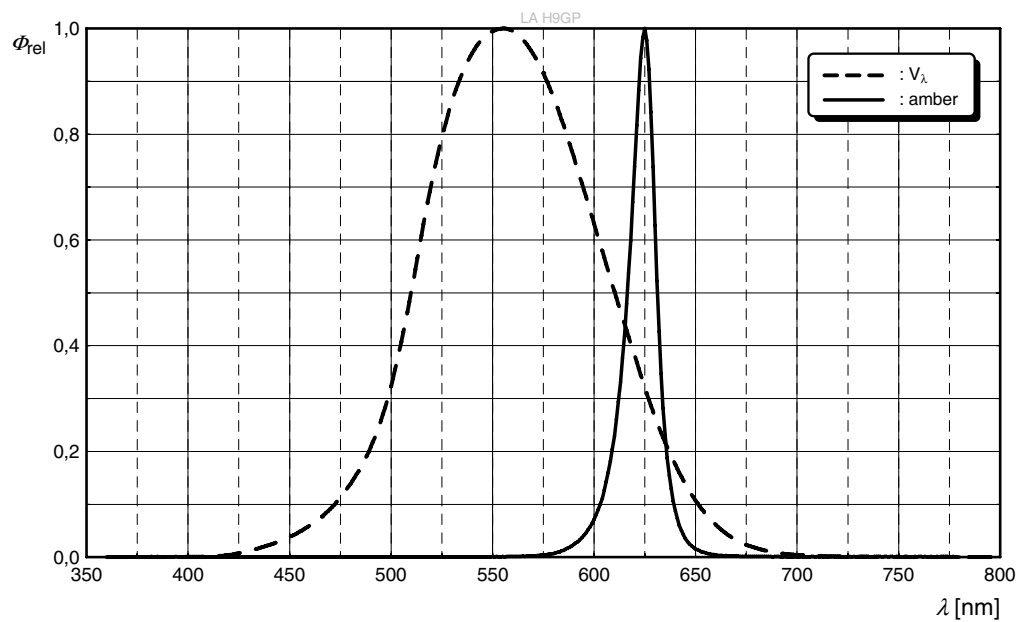
Group Name on Label

Example: JY-2-9B

| Brightness | Wavelength | Forward Voltage |
|------------|------------|-----------------|
| JY         | 2          | 9B              |

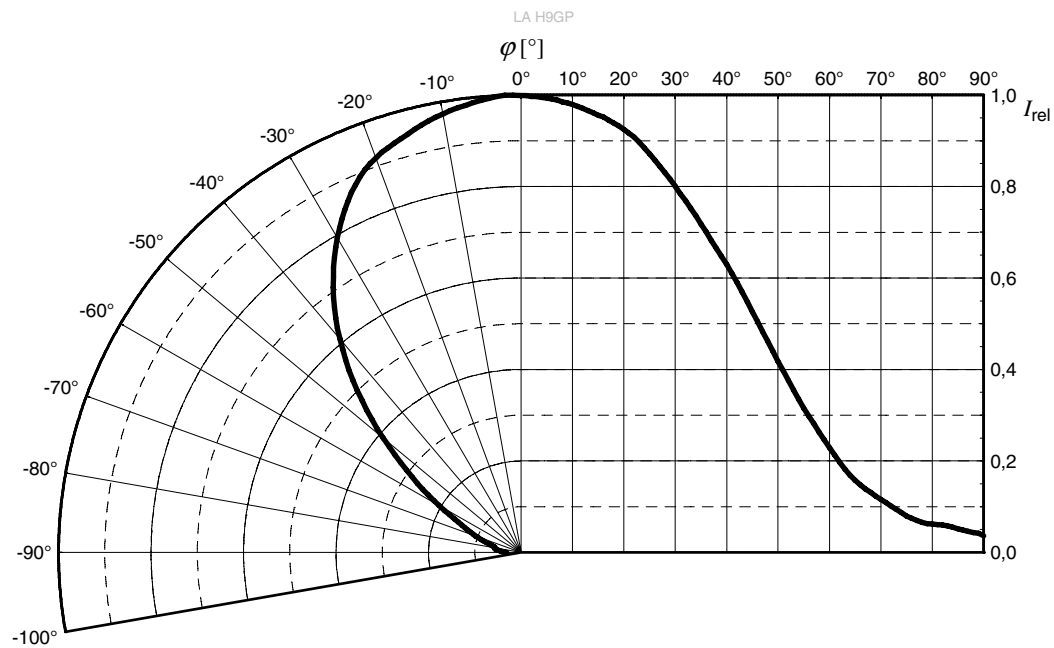
## Relative Spectral Emission <sup>6)</sup>

$\Phi_{\text{rel}} = f(\lambda)$ ;  $I_F = 350 \text{ mA}$ ;  $T_S = 25 \text{ °C}$



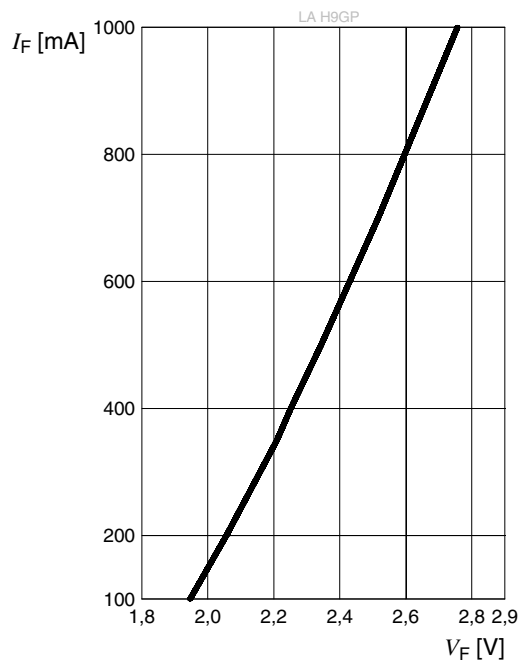
## Radiation Characteristics <sup>6)</sup>

$I_{\text{rel}} = f(\phi)$ ;  $T_S = 25 \text{ °C}$

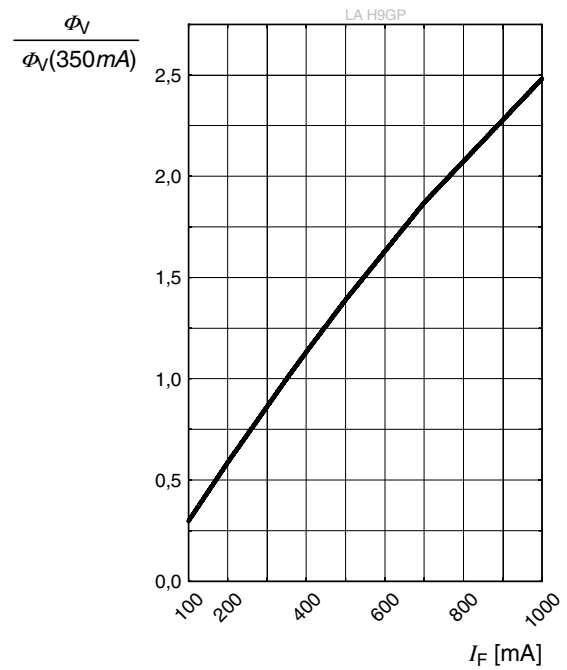


**Forward current** 6), 7)

$$I_F = f(V_F); T_S = 25\text{ °C}$$

**Relative Luminous Flux** 6), 7)

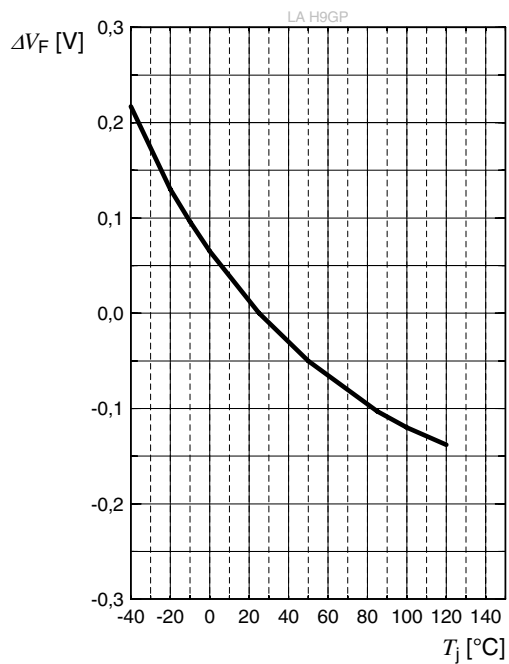
$$\Phi_V / \Phi_V(350\text{ mA}) = f(I_F); T_S = 25\text{ °C}$$



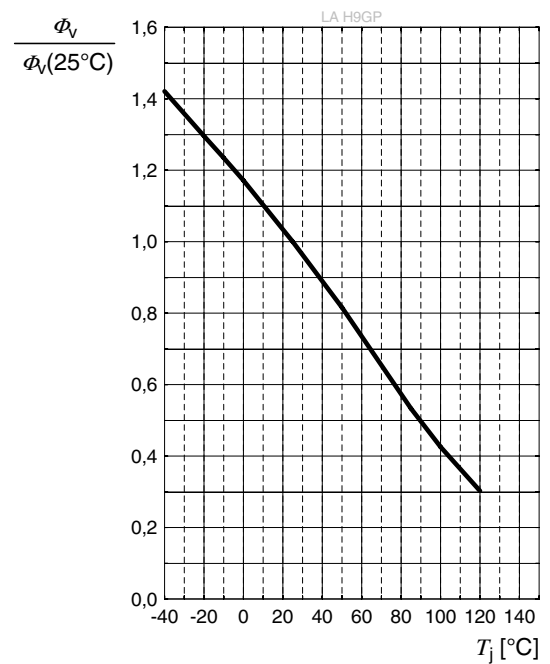


**Forward Voltage** <sup>6)</sup>

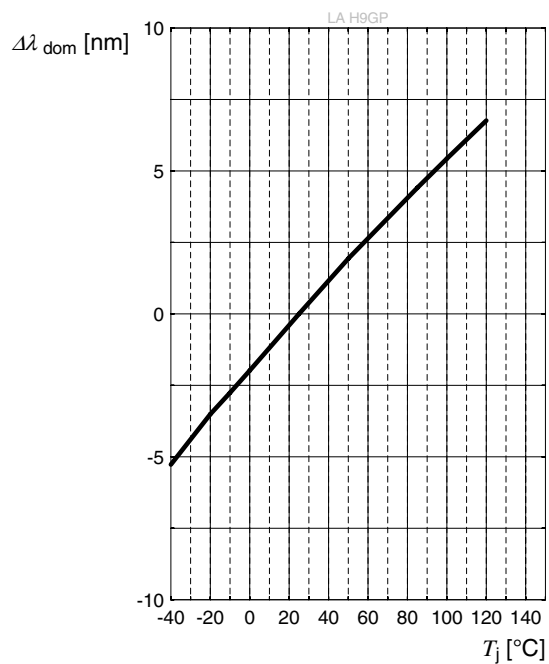
$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$

**Relative Luminous Flux** <sup>6)</sup>

$$\Phi_V / \Phi_V(25^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$

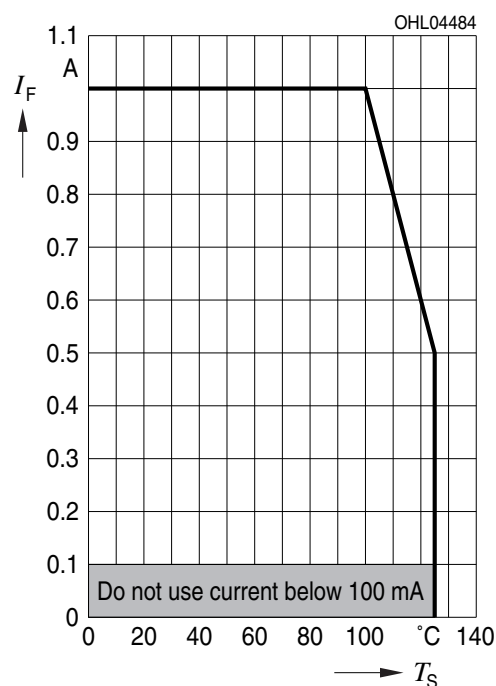
**Dominant Wavelength** <sup>6)</sup>

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25^\circ\text{C}) = f(T_j); I_F = 350\text{ mA}$$



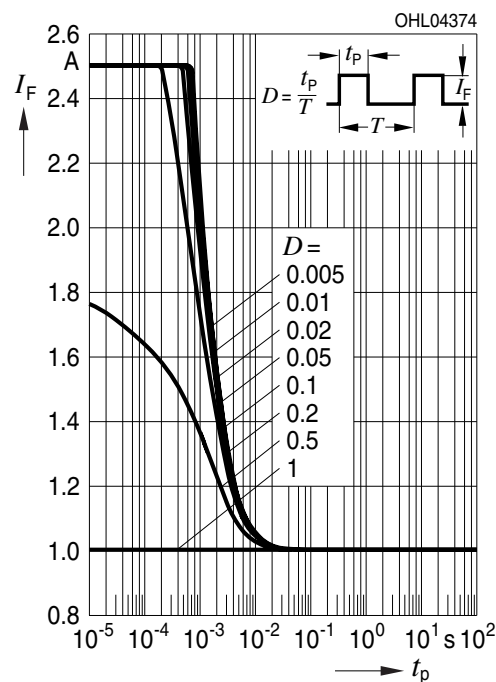
## Max. Permissible Forward Current

$$I_F = f(T)$$



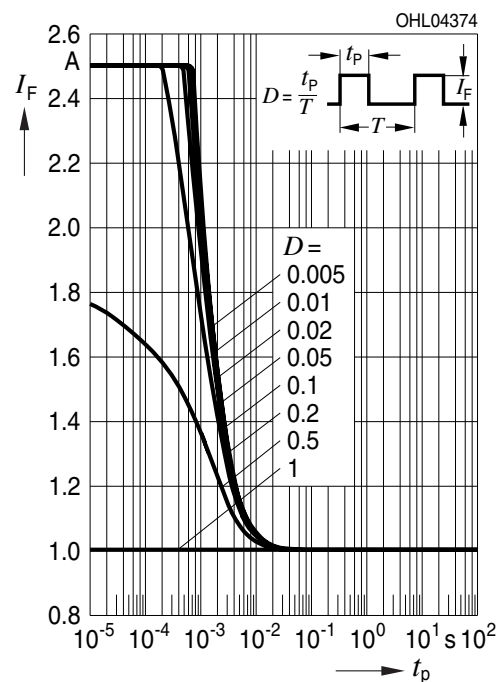
## Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_S = 25^\circ\text{C}$$

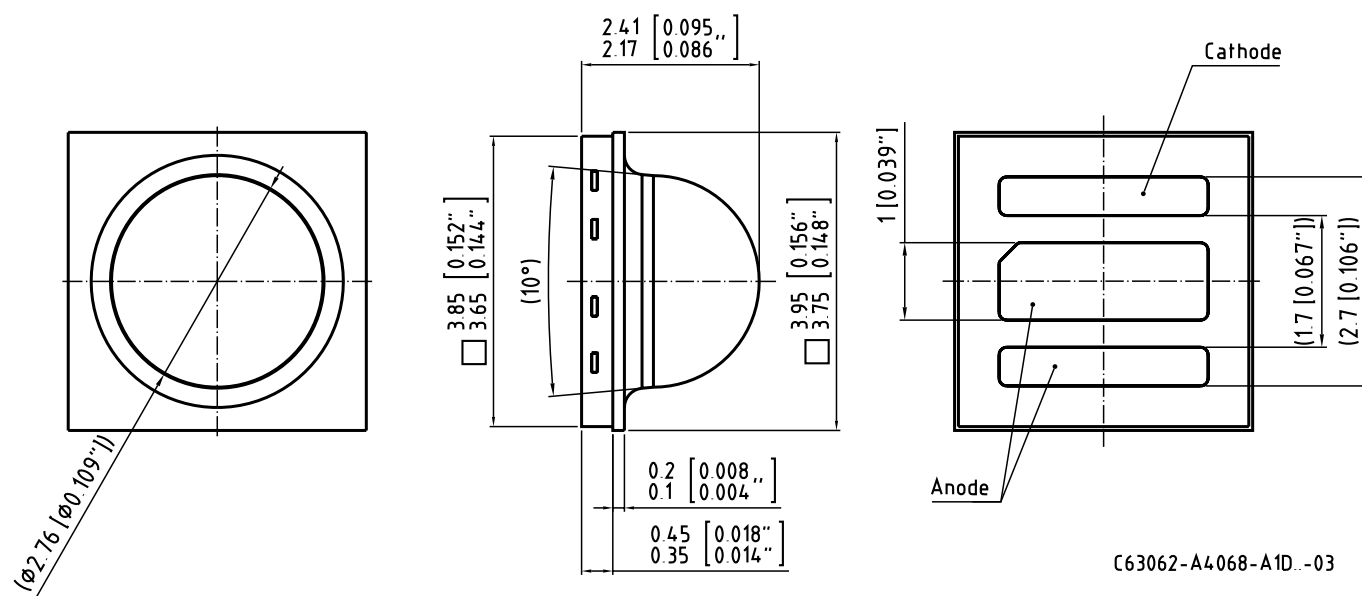


## Permissible Pulse Handling Capability

$$I_F = f(t_p); D: \text{Duty cycle}; T_S = 85^\circ\text{C}$$



## Dimensional Drawing <sup>8)</sup>



### Further Information:

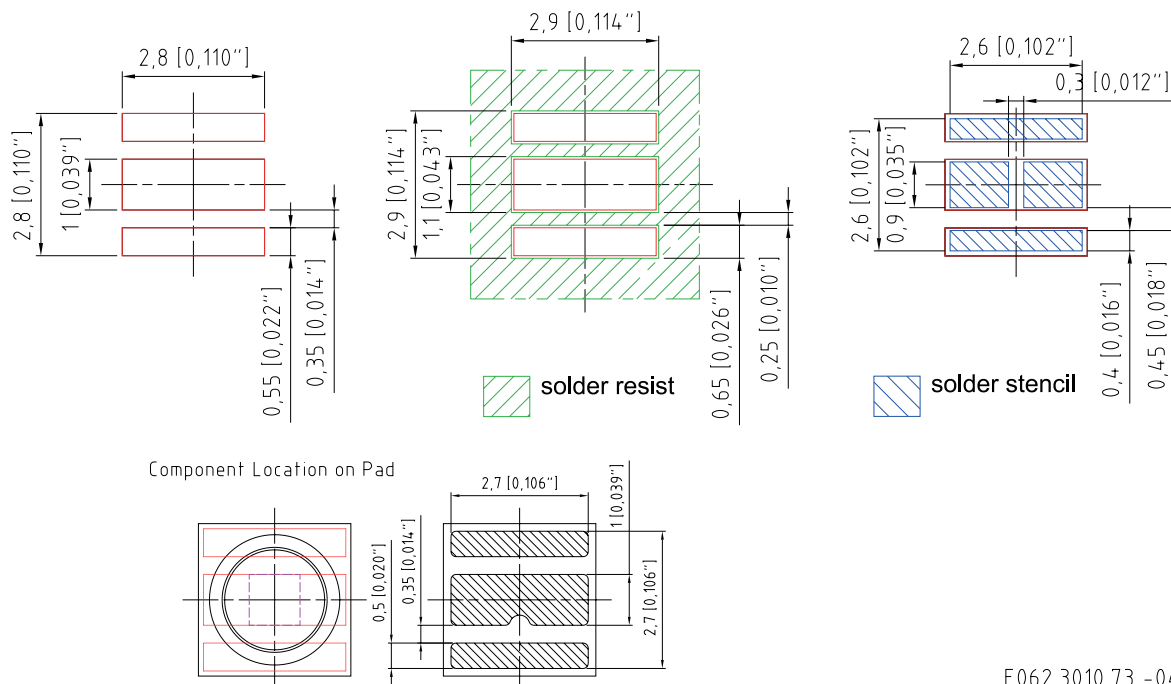
**Approximate Weight:** 32.0 mg

**Package marking:** Cathode

**Corrosion test:** Class: 3B  
 Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC 60068-2-43)

**ESD advice:** The device is protected by ESD device which is connected in parallel to the Chip.

## Recommended Solder Pad <sup>8)</sup>

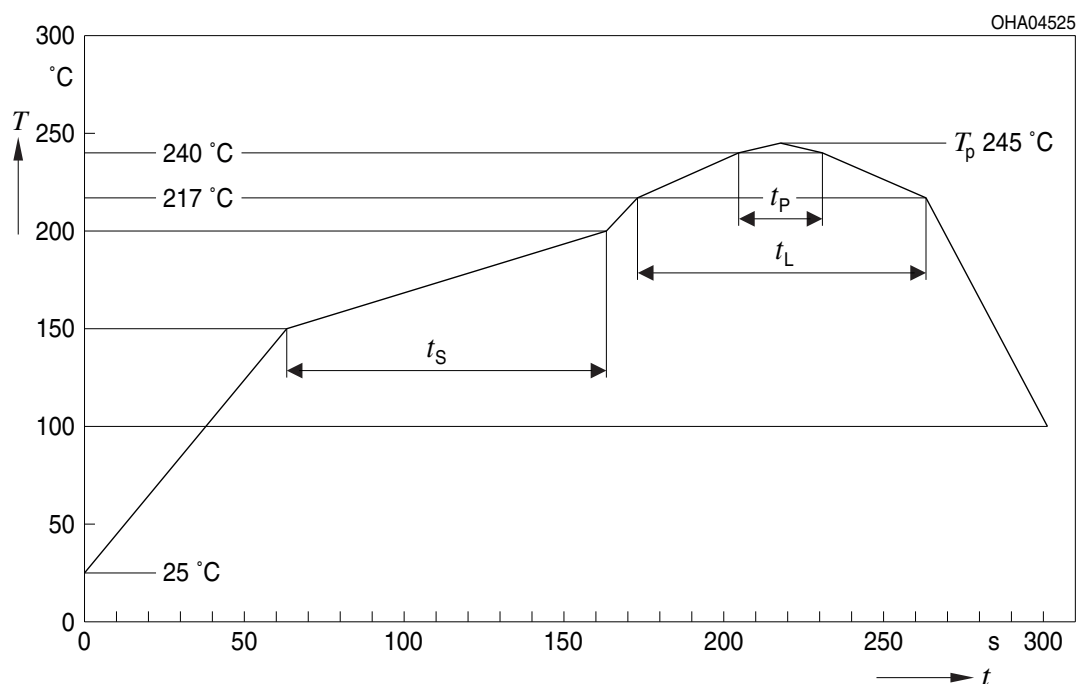


E062.3010.73 -04

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. In case the PCB layout of the application is intended to be used with other OSRON derivatives or in future developed OSRON derivatives, the heat sink must not be electrically connected to anode or cathode solder pad because of possible chip inverted polarity. Package not suitable for ultra sonic cleaning. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

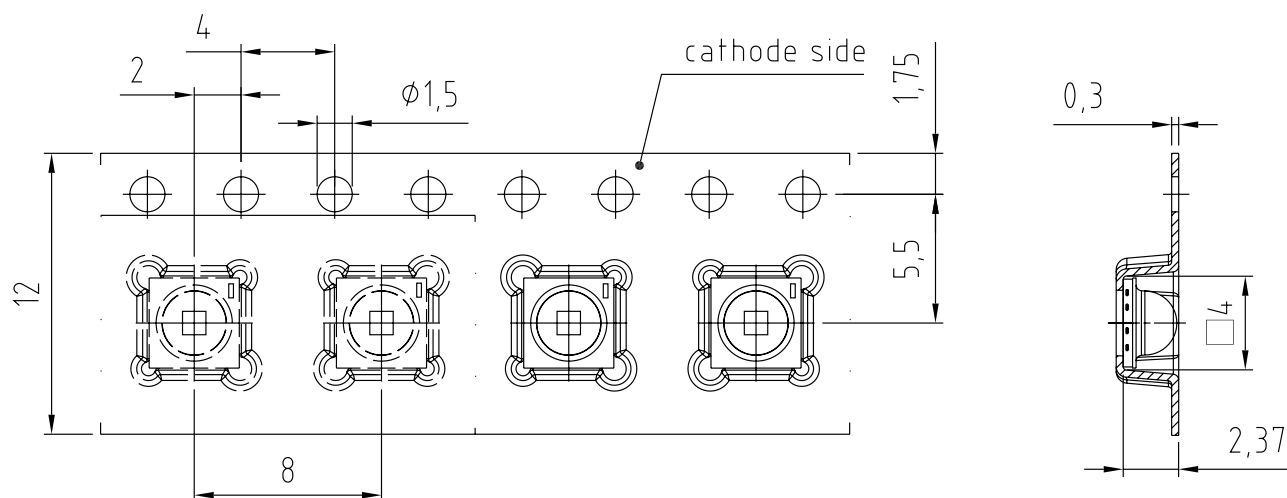


| Profile Feature                                                        | Symbol | Pb-Free (SnAgCu) Assembly |                |         | Unit               |
|------------------------------------------------------------------------|--------|---------------------------|----------------|---------|--------------------|
|                                                                        |        | Minimum                   | Recommendation | Maximum |                    |
| Ramp-up rate to preheat <sup>*)</sup><br>25 °C to 150 °C               |        |                           | 2              | 3       | K/s                |
| Time $t_s$<br>$T_{Smin}$ to $T_{Smax}$                                 | $t_s$  | 60                        | 100            | 120     | s                  |
| Ramp-up rate to peak <sup>*)</sup><br>$T_{Smax}$ to $T_p$              |        |                           | 2              | 3       | K/s                |
| Liquidus temperature                                                   | $T_L$  |                           | 217            |         | $^{\circ}\text{C}$ |
| Time above liquidus temperature                                        | $t_L$  |                           | 80             | 100     | s                  |
| Peak temperature                                                       | $T_p$  |                           | 245            | 260     | $^{\circ}\text{C}$ |
| Time within 5 °C of the specified peak temperature $T_p - 5 \text{ K}$ | $t_p$  | 10                        | 20             | 30      | s                  |
| Ramp-down rate*<br>$T_p$ to 100 °C                                     |        |                           | 3              | 6       | K/s                |
| Time<br>25 °C to $T_p$                                                 |        |                           |                | 480     | s                  |

All temperatures refer to the center of the package, measured on the top of the component

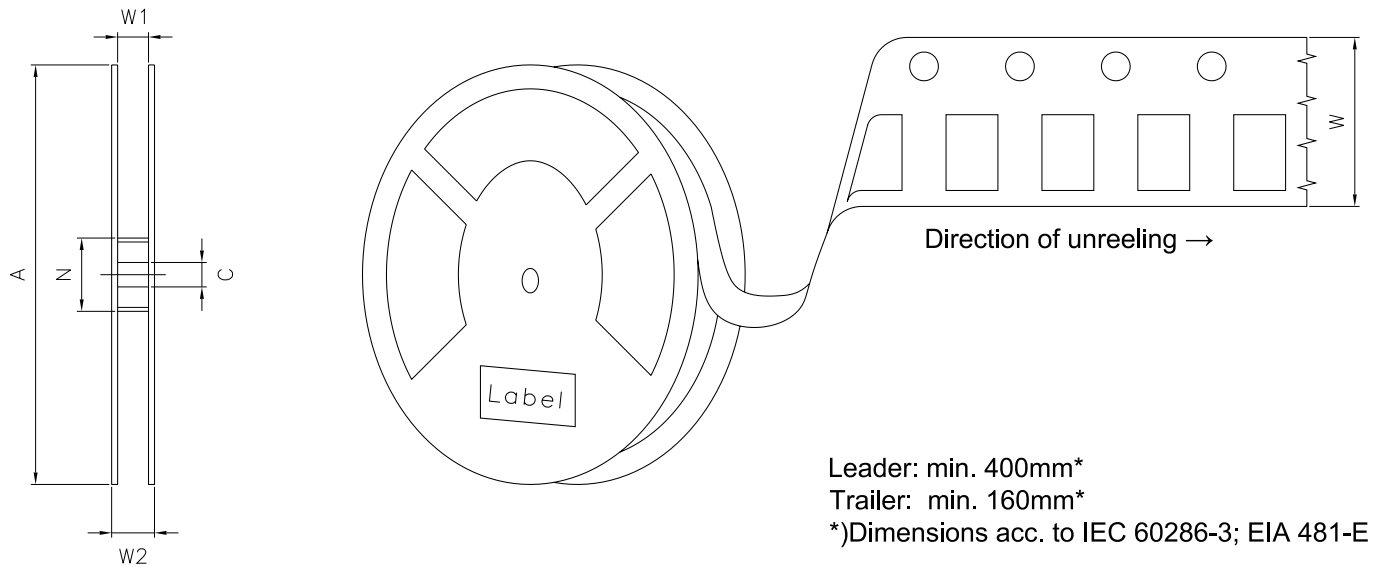
\* slope calculation  $DT/Dt$ :  $Dt$  max. 5 s; fulfillment for the whole T-range

## Taping <sup>8)</sup>



C63062-A4068-B10 -12

## Tape and Reel <sup>9)</sup>



## Reel Dimensions

| A      | W                   | N <sub>min</sub> | W <sub>1</sub> | W <sub>2 max</sub> | Pieces per PU |
|--------|---------------------|------------------|----------------|--------------------|---------------|
| 180 mm | 12 + 0.3 / - 0.1 mm | 60 mm            | 12.4 + 2 mm    | 18.4 mm            | 600           |
| 330 mm | 12 + 0.3 / - 0.1 mm | 60 mm            | 12.4 + 2 mm    | 18.4 mm            | 3000          |

## Barcode-Product-Label (BPL)

**OSRAM Opto Semiconductors**

LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890

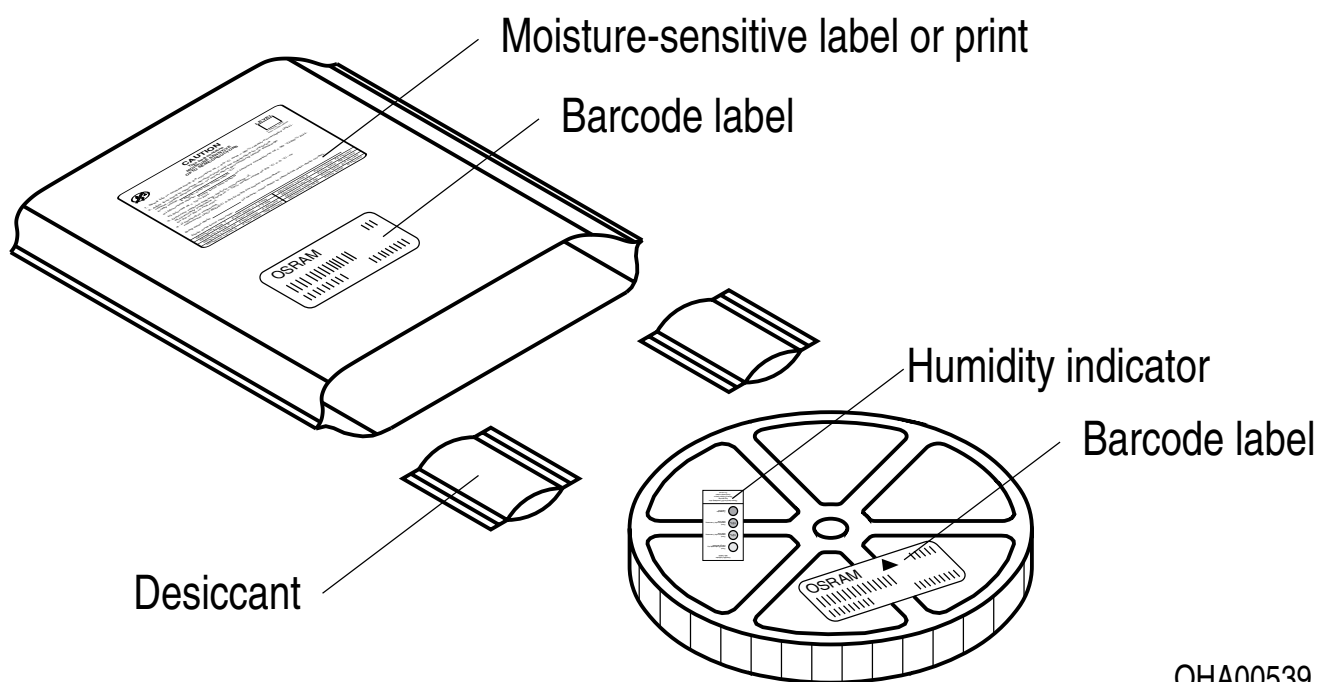
(1T) LOT NO: 1234567890 (9D) D/C: 1234

ML Temp ST  
X XXX °C X

Pack: RXX  
DEMY XXX  
X\_X123\_1234.1234 X

(X) PROD NO: 123456789 (Q) QTY: 9999 (G) GROUP: XX-XX-X-X

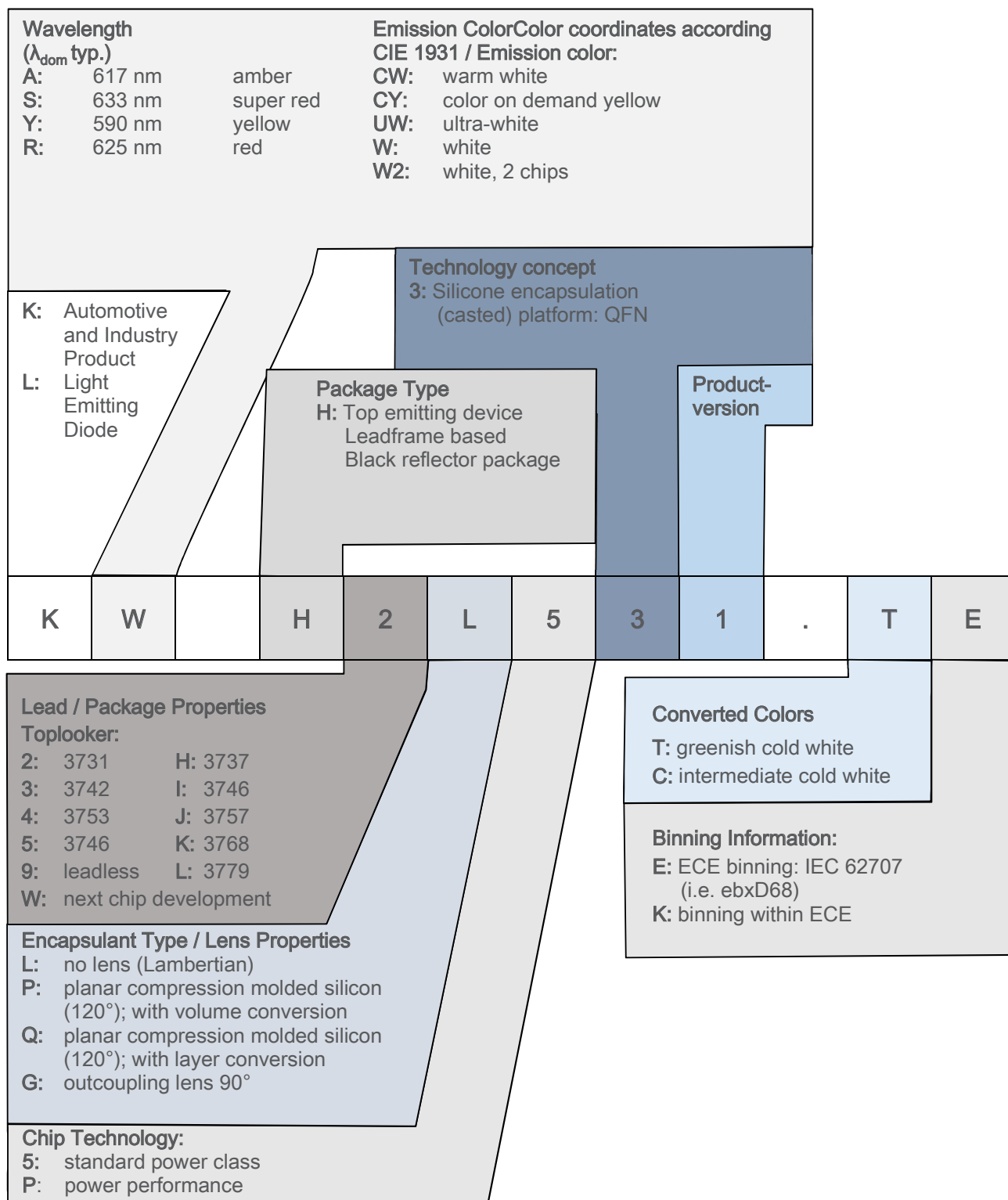
OHA04563

Dry Packing Process and Materials <sup>8)</sup>

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



## Type Designation System



## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)

## Disclaimer

### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

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## Glossary

- 1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8\%$  and an expanded uncertainty of  $\pm 11\%$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 2) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 3) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.5\text{ nm}$  and an expanded uncertainty of  $\pm 1\text{ nm}$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 4) **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05\text{ V}$  and an expanded uncertainty of  $\pm 0.1\text{ V}$  (acc. to GUM with a coverage factor of  $k = 3$ ).
- 5) **Thermal Resistance:**  $R_{th\text{ max}}$  is based on statistic values ( $6\sigma$ ).
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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## Revision History

| Version | Date       | Change                                                                                                                                                                                                         |
|---------|------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1.7     | 2020-01-30 | Features<br>Further Information<br>Reel Dimensions<br>Schematic Transportation Box<br>Dimensions of Transportation Box<br>Type Designation System<br>Notes<br>Disclaimer<br>Glossary<br>Recommended Solder Pad |

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EU RoHS and China RoHS compliant product



此产品符合欧盟 RoHS 指令的要求；  
按照中国的相关法规和标准，不含有毒有害物质或元素。



**Стандарт  
Электрон  
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

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С нами вы становитесь еще успешнее!

**Наши контакты:**

**Телефон:** +7 812 627 14 35

**Электронная почта:** [sales@st-electron.ru](mailto:sales@st-electron.ru)

**Адрес:** 198099, Санкт-Петербург,  
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